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ON Semiconductor®

FDS6612A

Single N-Channel, Logic-Level, PowerTrench® MOSFET

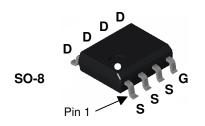
General Description

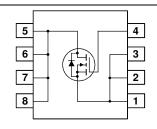
This N-Channel Logic Level MOSFET is produced using ON Semiconductor's advanced PowerTrench process that has been especially tailored to minimize the on-state resistance and yet maintain superior switching performance.

These devices are well suited for low voltage and battery powered applications where low in-line power loss and fast switching are required.

Features

- 8.4 A, 30 V. $R_{DS(ON)} = 22 \ m\Omega \ @ \ V_{GS} = 10 \ V$ $R_{DS(ON)} = 30 \ m\Omega \ @ \ V_{GS} = 4.5 \ V$
- · Fast switching speed
- · Low gate charge
- High performance trench technology for extremely low $R_{\text{DS}(\text{ON})}$
- · High power and current handling capability





Absolute Maximum Ratings TA=25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
V _{DSS}	Drain-Source Voltage		30	V
V _{GSS}	Gate-Source Voltage		±20	V
I _D	Drain Current - Continuous	(Note 1a)	8.4	Α
	- Pulsed		40	1
P _D	Power Dissipation for Single Operation	(Note 1a)	2.5	W
		(Note 1b)	1.0	1
E _{AS}	Single Pulse Avalanche Energy	(Note 3)	24	mJ
T_J, T_{STG}	Operating and Storage Junction Temperature Range		−55 to +150	°C

Thermal Characteristics

Thormal onaractoriono						
R _{eJA}	Thermal Resistance, Junction-to-Ambient	(Note 1a)	50	°C/W		
R _{eJA}	Thermal Resistance, Junction-to-Ambient	(Note 1b)	125			
R _{eJC}	Thermal Resistance, Junction-to-Case	(Note 1)	25			

Package Marking and Ordering Information

Device Marking	Device	Reel Size	Tape width	Quantity
FDS6612A	FDS6612A	13"	12mm	2500 units

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Publication Order Number: FDS6612A/D

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Char	acteristics	1			I	ı
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, \qquad I_D = 250 \mu\text{A}$	30			V
<u>ΔBV_{DSS}</u> ΔT _J	Breakdown Voltage Temperature Coefficient	I_D = 250 μ A, Referenced to 25°C		26		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 24 \text{ V}, \qquad V_{GS} = 0 \text{ V}$			1	μΑ
		$V_{DS} = 24 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55^{\circ}\text{C}$			10	μΑ
I _{GSS}	Gate-Body Leakage	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±100	nA
On Char	acteristics (Note 2)					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	1	1.9	3	V
$\Delta V_{GS(th)} \over \Delta T_J$	Gate Threshold Voltage Temperature Coefficient	$I_D = 250 \mu\text{A}$, Referenced to 25°C		-4.4		mV/°C
R _{DS(on)}	Static Drain–Source On–Resistance	$\begin{split} V_{GS} &= 10 \ V, & I_D = 8.4 \ A \\ V_{GS} &= 4.5 \ V, & I_D = 7.2 \ A \\ V_{GS} &= 10 \ V, I_D = 8.4 \ A, T_J = 125 ^{\circ} C \end{split}$		19 24 25	22 30 37	mΩ
I _{D(on)}	On-State Drain Current	V _{GS} = 10 V, V _{DS} = 5 V	20			Α
g FS	Forward Transconductance	$V_{DS} = 15 \text{ V}, \qquad I_{D} = 8.4 \text{ A}$		30		S
Dynamic	Characteristics			•	•	•
C _{iss}	Input Capacitance	$V_{DS} = 15 \text{ V}, \qquad V_{GS} = 0 \text{ V},$		560		pF
Coss	Output Capacitance	f = 1.0 MHz		140		pF
C _{rss}	Reverse Transfer Capacitance			55		pF
R_G	Gate Resistance	$V_{GS} = 15 \text{ mV}, f = 1.0 \text{ MHz}$		2.5		Ω
Switchin	g Characteristics (Note 2)					
t _{d(on)}	Turn-On Delay Time	$V_{DD} = 15 \text{ V}, \qquad I_D = 1 \text{ A},$		7	14	ns
t _r	Turn-On Rise Time	$V_{GS} = 10 \text{ V}, \qquad R_{GEN} = 6 \Omega$		5	10	ns
t _{d(off)}	Turn-Off Delay Time			22	35	ns
t _f	Turn-Off Fall Time			3	6	ns
Q_g	Total Gate Charge	$V_{DS} = 15 \text{ V}, \qquad I_D = 8.4 \text{ A},$		5.4	7.6	nC
Q_{gs}	Gate-Source Charge	$V_{GS} = 5 V$		1.7		nC
Q_{gd}	Gate-Drain Charge			1.9		nC
Drain-So	ource Diode Characteristics	and Maximum Ratings				
Is	Maximum Continuous Drain-Source	e Diode Forward Current			2.1	Α
V _{SD}	Drain-Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}, \qquad I_{S} = 2.1 \text{ A (Note 2)}$		0.77	1.2	V
t _{rr}	Diode Reverse Recovery Time	1 - 9.4 A d /d 100 A/va		19		nS
Q _{rr}	Diode Reverse Recovery Charge	$I_F = 8.4 \text{ A}, d_{iF}/d_t = 100 \text{ A/}\mu\text{s}$		9		nC

Notes

R_{aJA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{aJC} is guaranteed by design while R_{eCA} is determined by the user's board design.



a) 50 °C/W when mounted on a 1in² pad of 2 oz copper



b) 125°C/W when mounted on a minimum pad.

Scale 1:1 on letter size paper

2 Test: Pulse Width < 300µs, Duty Cycle < 2.0% 3 Starting TJ = 25°C, L = 1mH, I_{AS} = 7A, V_{DD} = 27V, V_{GS} = 10V

Typical Characteristics

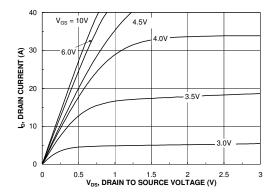


Figure 1. On-Region Characteristics.

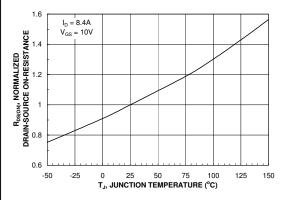


Figure 3. On-Resistance Variation with Temperature.

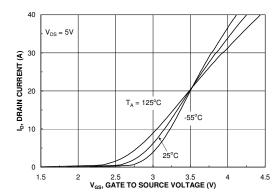


Figure 5. Transfer Characteristics.

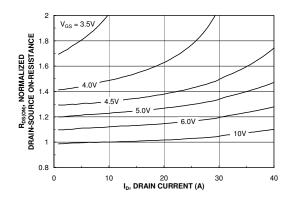


Figure 2. On-Resistance Variation with Drain Current and Gate Voltage.

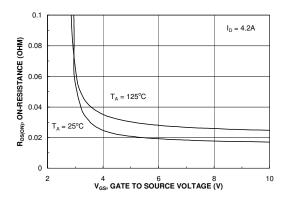


Figure 4. On-Resistance Variation with Gate-to-Source Voltage.

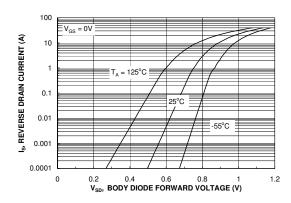
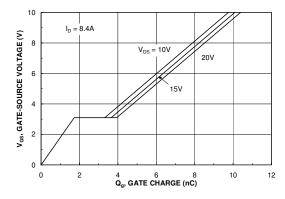


Figure 6. Body Diode Forward Voltage Variation with Source Current and Temperature.

Typical Characteristics



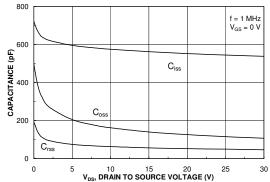
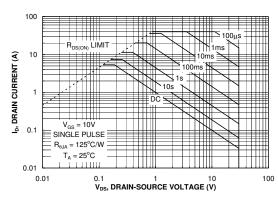


Figure 7. Gate Charge Characteristics.





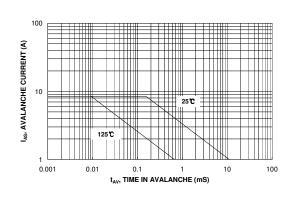


Figure 9. Maximum Safe Operating Area.

Figure 10. Unclamped Inductive Switching Capability

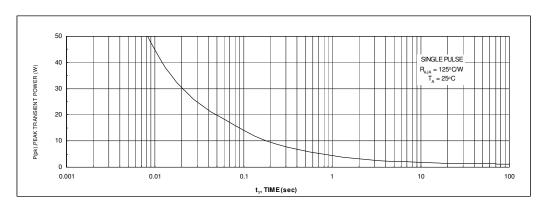


Figure 11. Single Pulse Maximum Power Dissipation.

Typical Characteristics

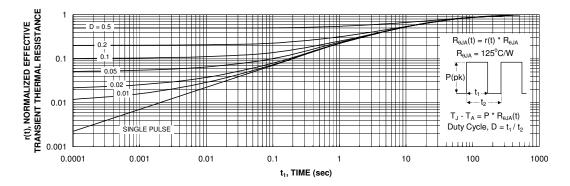
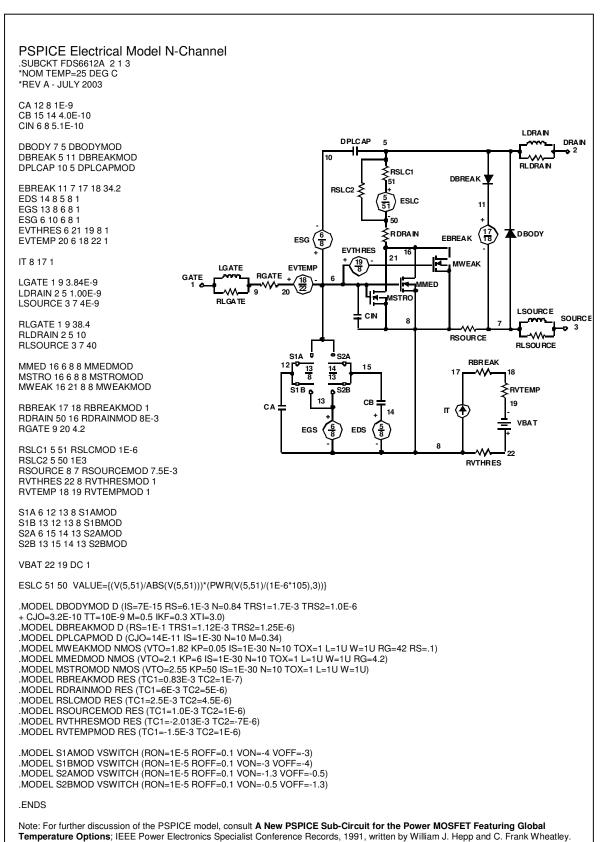


Figure 12. Transient Thermal Response Curve.

Thermal characterization performed using the conditions described in Note 1c. Transient thermal response will change depending on the circuit board design.



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AMBIENT

SPICE Thermal Model .SUBCKT FDS6612A_THERM TH TL JUNCTION th *THERMAL MODEL SUBCIRCUIT *REV A - JULY 2003 *MIN PAD RJA RTHERM1 CTHERM1 CTHERM1 ΤH 0.005 CTHERM2 0.05 8 CTHERM3 6 0.10 RTHERM2 CTHERM2 CTHERM4 6 5 0.35 CTHERM5 4 5 0.45 3 2 TL CTHERM6 4 0.50 CTHERM7 3 0.55 RTHERM3 CTHERM3 2 CTHERM8 3.00 ΤH 5.000 RTHERM1 8 6.250 RTHERM2 8 RTHERM4 CTHERM4 RTHERM3 7 6 7.500 RTHERM4 8.750 6 5 5 RTHERM5 5 4 10.625 RTHERM6 4 3 11.875 CTHERM5 RTHERM5 2 RTHERM7 3 31.250 RTHERM8 TL 43.750 4 .ENDS RTHERM6 CTHERM6 RTHERM7 CTHERM7 CTHERM8 RTHERM8

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